

RGT30TM65D 650V 15A Field Stop Trench IGBT

V _{CES}	650V
I _{C(100°C)}	8A
V _{CE(sat) (Typ.)}	1.65V@I _c =15A
P _D	32W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) Low Switching Loss
- 3) Short Circuit Withstand Time 5µs
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating ; RoHS Compliant

Applications

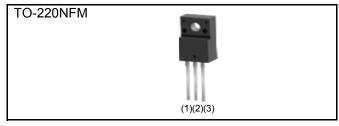
General Inverter

UPS

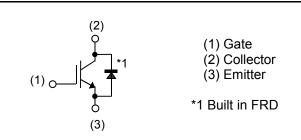
Power Conditioner

Welder

Outline



Inner Circuit



Packaging Specifications

Туре	Packaging	Tube
	Reel Size (mm)	-
	Tape Width (mm)	-
	Basic Ordering Unit (pcs)	1,000
	Packing Code	C9
	Marking	RGT30TM65D

•Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

		,		
Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V _{CES}	650	V
Gate - Emitter Voltage		V _{GES}	±30	V
Collector Current	T _C = 25°C	۱ _C	14	A
Collector Current	T _C = 100°C	Ι _C	8	А
Pulsed Collector Current		I _{CP} *1	45	A
Diode Forward Current	T _C = 25°C	١ _F	17	А
Diode Forward Current	T _C = 100°C	١ _F	9	А
Diode Pulsed Forward Current		I _{FP} ^{*1}	45	А
Power Dissipation	T _C = 25°C	P _D	32	W
Power Dissipation	T _C = 100°C	P _D	16	W
Operating Junction Temperature		Tj	-40 to +175	°C
Storage Temperature		T _{stg}	-55 to +175	°C
*1 Dulco width limited by T				

*1 Pulse width limited by T_{jmax.}

Thermal Resistance

Parameter	Symbol	Values			Unit
Faranieter	Symbol	Min.	Тур.	Max.	Unit
Thermal Resistance IGBT Junction - Case	$R_{\theta(j\text{-}c)}$	-	-	4.59	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j\text{-}c)}$	-	-	5.44	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit	
Faranieler	Symbol	Conditions	Min.	Тур.	Max.	Onit	
Collector - Emitter Breakdown Voltage	BV _{CES}	I _C = 10μΑ, V _{GE} = 0V	650	-	-	V	
Collector Cut - off Current	I _{CES}	V _{CE} = 650V, V _{GE} = 0V	-	-	10	μA	
Gate - Emitter Leakage Current	I _{GES}	V_{GE} = ±30V, V_{CE} = 0V	-	-	±200	nA	
Gate - Emitter Threshold Voltage	V _{GE(th)}	V _{CE} = 5V, I _C = 10.0mA	5.0	6.0	7.0	V	
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_{c} = 15A, V_{GE} = 15V$ $T_{j} = 25^{\circ}C$ $T_{j} = 175^{\circ}C$	-	1.65 2.15	2.1	V	

•IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Deremeter	O: make al	ool Conditions -	Values			1.1
Parameter	Symbol		Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	V _{CE} = 30V	-	780	-	
Output Capacitance	C _{oes}	V _{GE} = 0V	-	35	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	13	-	
Total Gate Charge	Q_g	V _{CE} = 300V	-	32	-	
Gate - Emitter Charge	Q_{ge}	I _C = 15A	-	8	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	11	-	
Turn - on Delay Time	t _{d(on)}	I _C = 15A, V _{CC} = 400V	-	18	-	
Rise Time	t _r	V _{GE} = 15V, R _G = 10Ω	-	20	-	ns
Turn - off Delay Time	$t_{d(off)}$	T _j = 25°C	-	64	-	
Fall Time	t _f	Inductive Load	-	75	-	
Turn - on Delay Time	t _{d(on)}	I _C = 15A, V _{CC} = 400V	-	18	-	
Rise Time	t _r	V _{GE} = 15V, R _G = 10Ω	-	22	-	
Turn - off Delay Time	$t_{d(off)}$	T _j = 175°C	-	74	-	ns
Fall Time	t _f	Inductive Load	-	130	-	
		I _C = 45A, V _{CC} = 520V			-	
Reverse Bias Safe Operating Area	RBSOA	V _P = 650V, V _{GE} = 15V	FU	LL SQUA	ARE	-
		R _G = 50Ω, T _j = 175°C				
		$V_{CC} \leq 360V$				
Short Circuit Withstand Time	t _{sc}	V _{GE} = 15V	5	-	-	μs
		T _j = 25°C				

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•FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			Linit
			Min.	Тур.	Max.	Unit
Diode Forward Voltage	V _F	I _F = 15A T _j = 25°C T _j = 175°C	-	1.5 1.3	1.95 -	V
Diode Reverse Recovery Time	t _{rr}	I _F = 15A V _{CC} = 400V di _F /dt = 200A/µs T _j = 25°C	-	55	-	ns
Diode Peak Reverse Recovery Current	I _{rr}		-	6.0	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	0.19	-	μC
Diode Reverse Recovery Time	t _{rr}	I _F = 15A V _{CC} = 400V di _F /dt = 200A/µs T _j = 175°C	-	141	-	ns
Diode Peak Reverse Recovery Current	I _{rr}		-	9.5	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	0.79	-	μC

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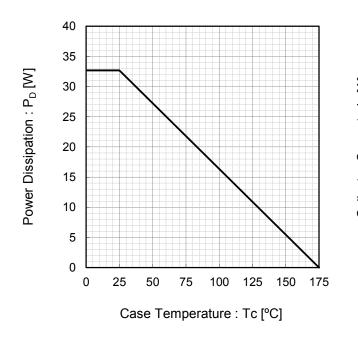


Fig.1 Power Dissipation vs. Case Temperature

Fig.2 Collector Current vs. Case Temperature

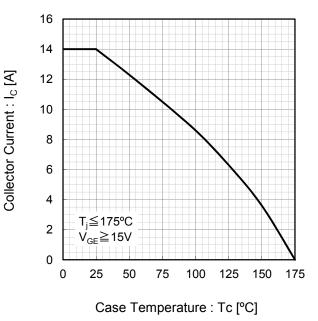
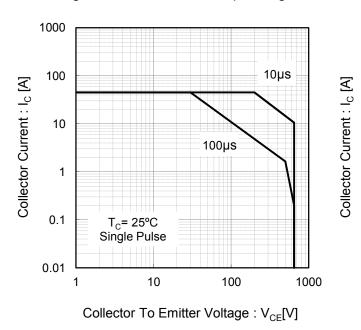
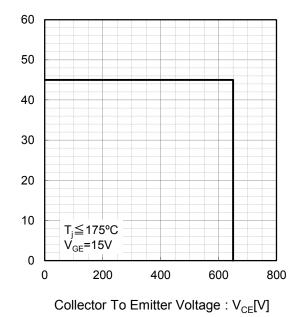


Fig.3 Forward Bias Safe Operating Area

Fig.4 Reverse Bias Safe Operating Area





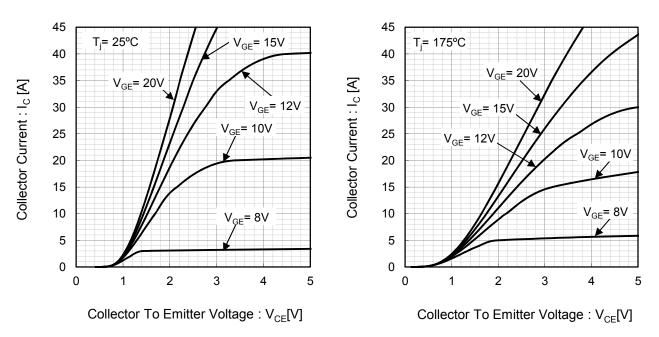
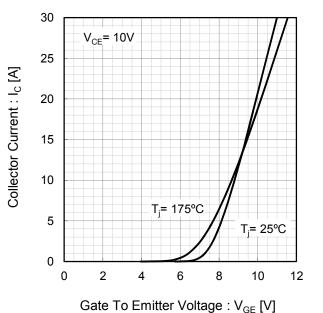


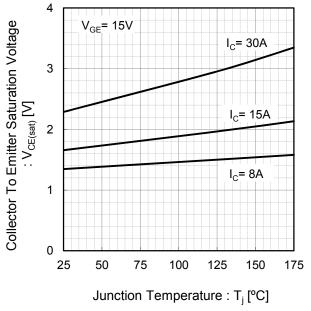
Fig.5 Typical Output Characteristics

Fig.7 Typical Transfer Characteristics

Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature

Fig.6 Typical Output Characteristics





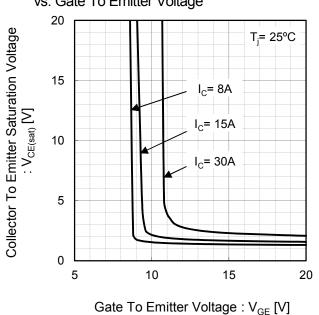


Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

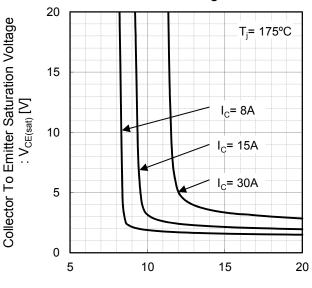
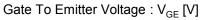


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



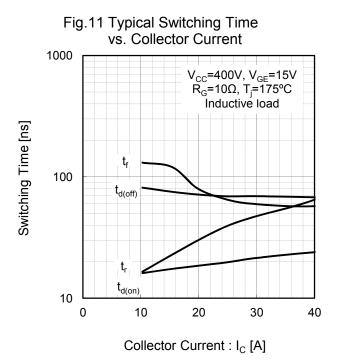
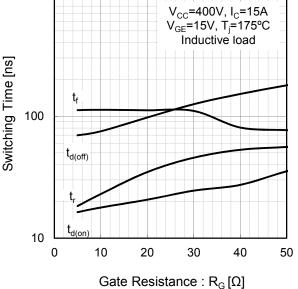
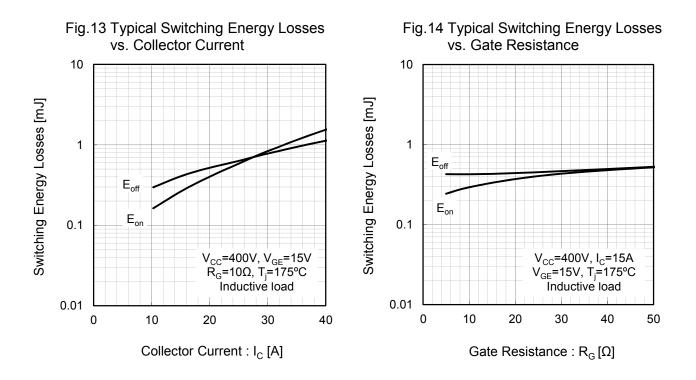
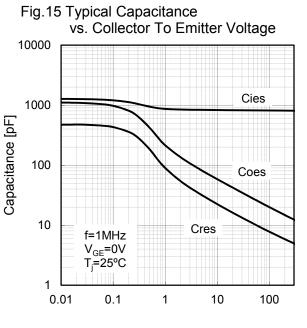


Fig.12 Typical Switching Time vs. Gate Resistance

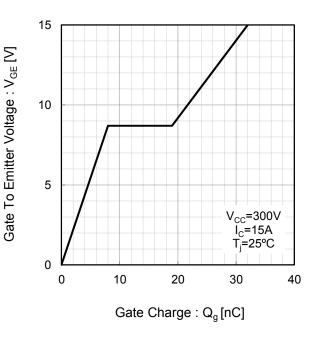






Collector To Emitter Voltage : V_{CE}[V]

Fig.16 Typical Gate Charge



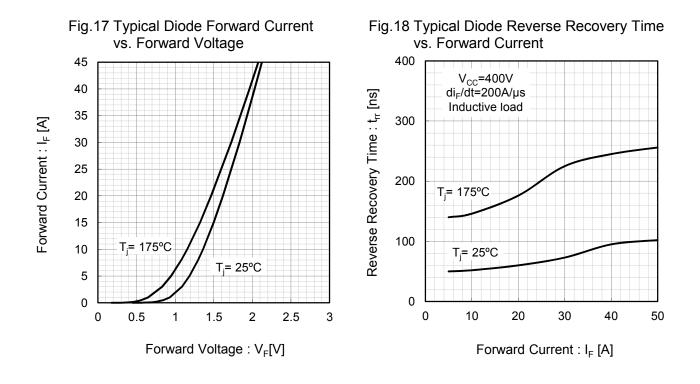


Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

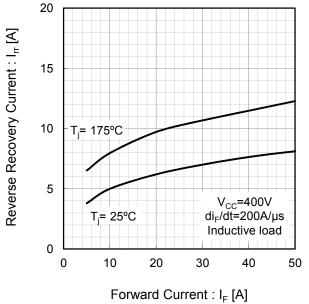
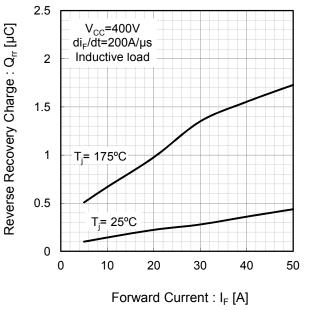


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current



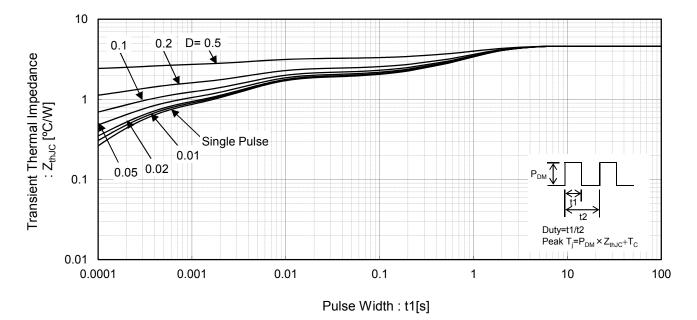
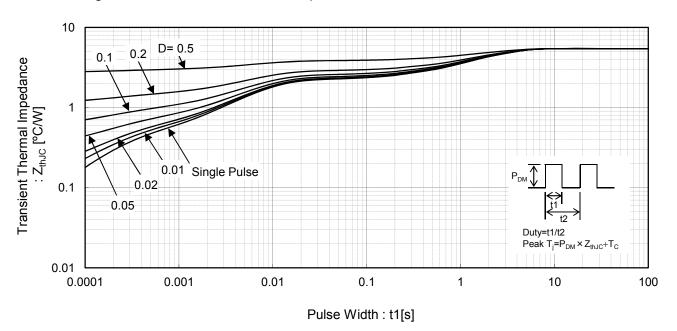


Fig.21 IGBT Transient Thermal Impedance





●Inductive Load Switching Circuit and Waveform

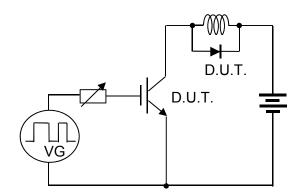


Fig.23 Inductive Load Circuit

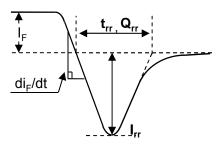


Fig.25 Diode Reverce Recovery Waveform

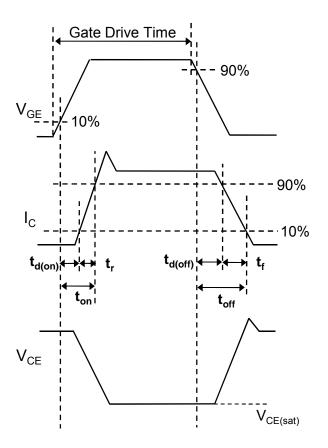


Fig.24 Inductive Load Waveform

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